



(3583)

2023/9/5

Safe Harbor Statement

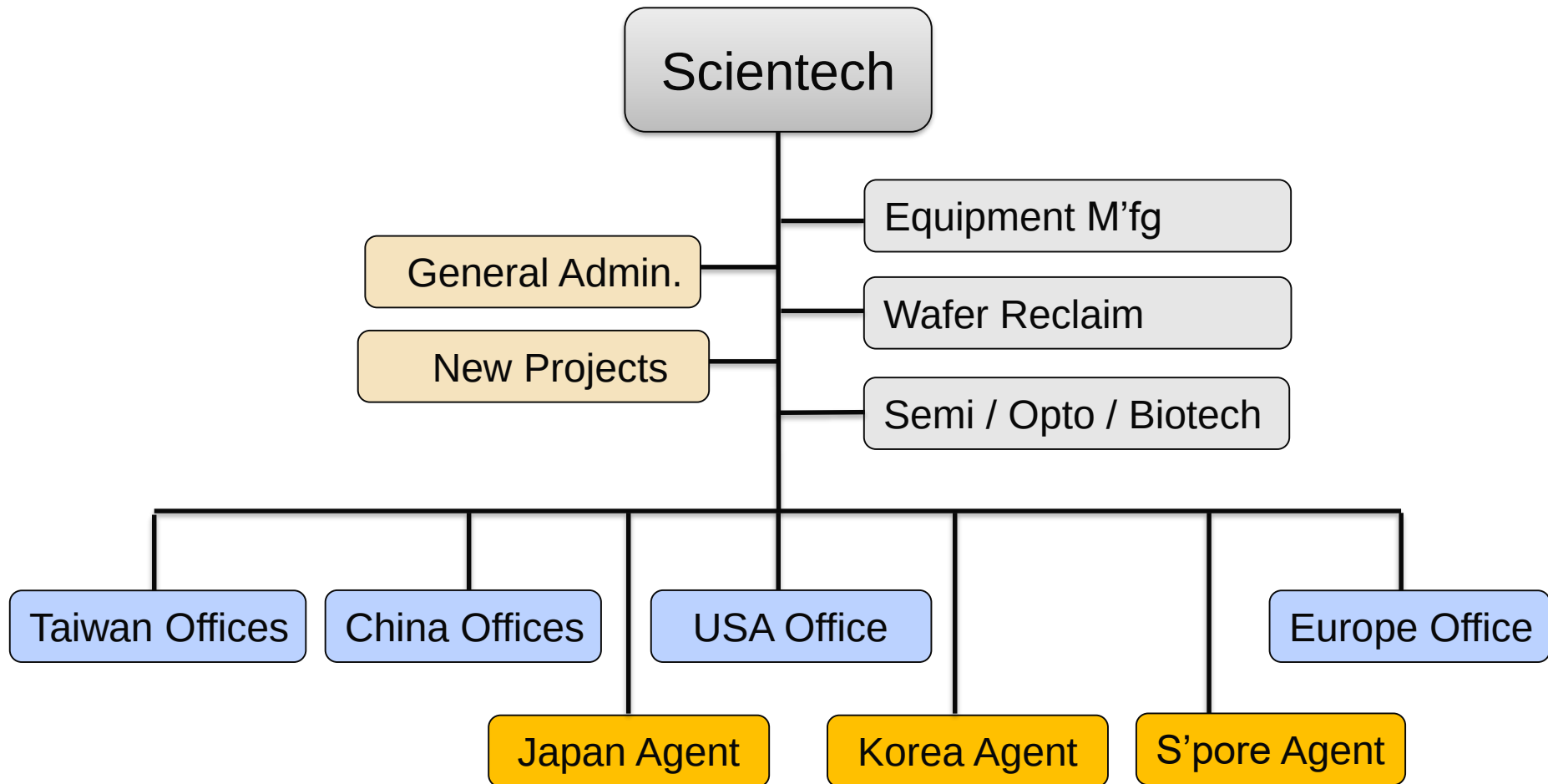
- This Presentation contains certain forward-looking statements that are based on current expectations and are subject to known and unknown risks and uncertainties that could cause actual results to differ materially from those expressed or implied by such statements.
- Except as required by law, we undertake no obligation to update any forward –looking statements, whether as a result of new information, future events or otherwise.

Sciencetech Corp (3583: TT)



Establishment	1979/10/17
Chairman & CEO	H.L. Hsieh
CEO	M.T. Hsu
Capital	NT\$ 811 Million
Revenue(2021)	NT\$ 4,684 Million (consolidated)
No. Employees	770 (Consolidated)
Location	1.Taiwan : Taipei, Hukou , Hsinchu, Tainan, Kaohsiung 2.Subsidiary Company : China(17 cities including Shanghai) , HK,USA , Europe(Austria) 3.Business Support : Japan,Singapore,South Korea
Products	Equipment Manufacturing 、 Wafer Reclaim 、 Trading(Agent/Distributor)

Organization



Business
Overview

Products

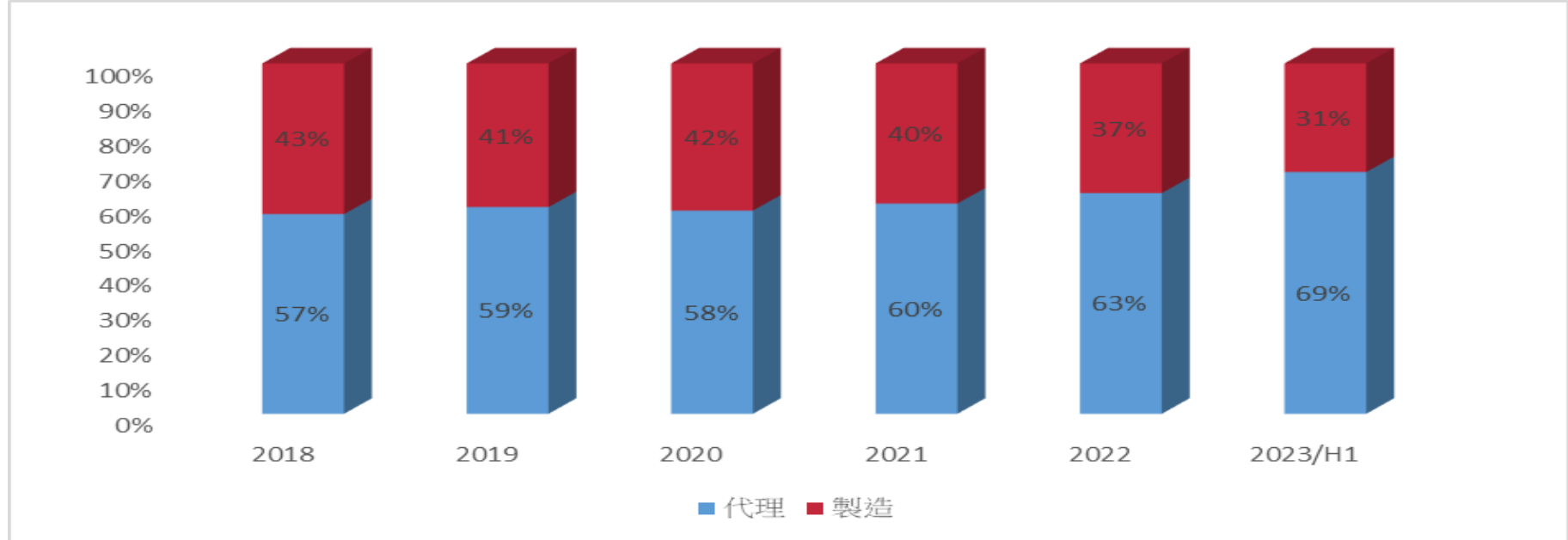
Corporate
Governance

Future
Prospect

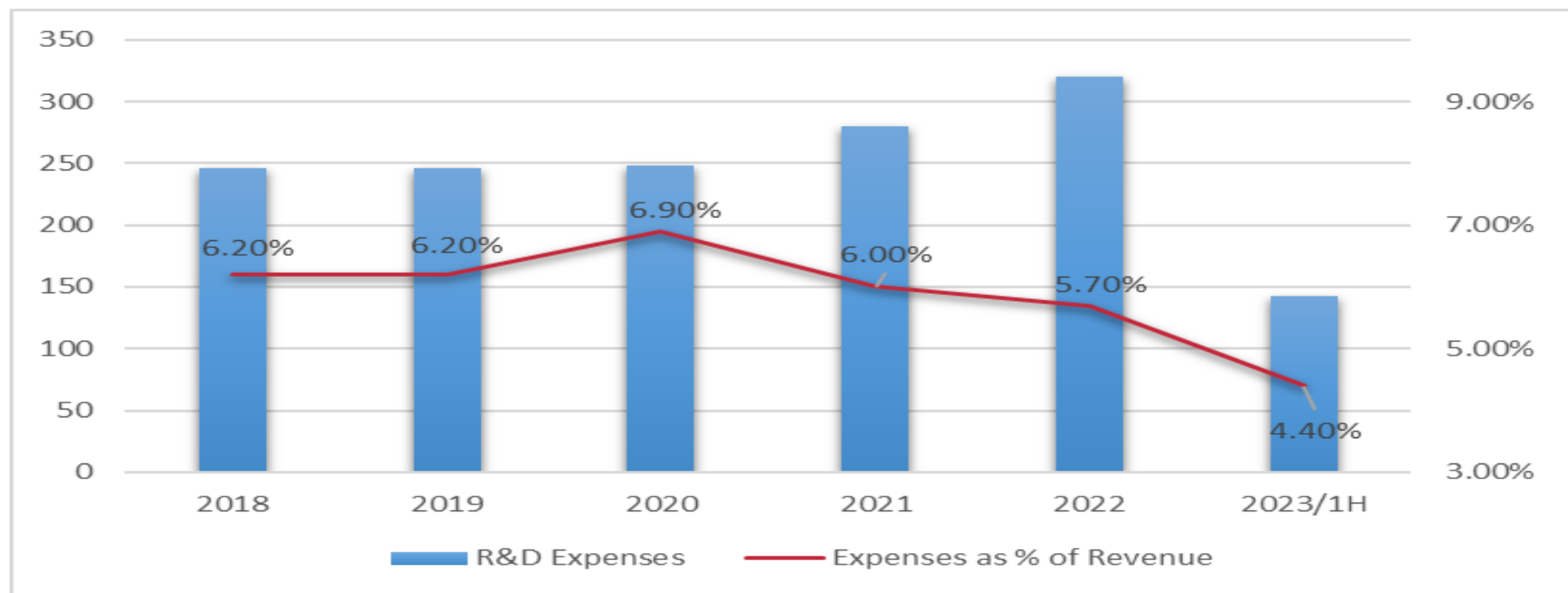
Units : NT \$ M	2018	2019	2020	2021	2022	2023/H1
Revenues	<u>3,988</u>	<u>3,949</u>	<u>3,580</u>	<u>4,684</u>	<u>5,650</u>	<u>3,230</u>
Gross Profit	<u>1,448</u>	<u>1,384</u>	<u>1,456</u>	<u>1,667</u>	<u>2,084</u>	<u>969</u>
Operating Expenses	935	997	991	1,112	1,374	685
Operating Income	514	387	465	555	710	284
Other Income and Expenses	26	16	(76)	(31)	26	86
Income Before Tax	540	403	389	524	736	370
Net Income	418	323	305	420	568	299
EPS	<u>5.16</u>	<u>4.02</u>	<u>3.80</u>	<u>5.23</u>	<u>7.08</u>	<u>3.73</u>
Gross Margin	36%	35%	41%	36%	37%	30%
Operating Margin	13%	10%	13%	12%	13%	9%
Income Before Tax margin	14%	10%	11%	11%	13%	11%

Units : NT \$ M	1Q22	2Q22	3Q22	4Q22	1Q23	2Q23	YoY
Revenues	1,254	1,383	1,440	1,573	1,618	1,611	16%
Gross Profit	461	511	536	576	515	457	-10%
Operating Expenses	332	338	354	350	329	356	5%
Operating Income	129	173	183	225	186	98	-43%
Other Income and Expenses	26	3	28	(30)	(8)	94	3275%
Income Before Tax	155	176	211	195	178	192	9%
Net Income	121	152	152	143	145	154	%
EPS	1.51	1.89	1.89	1.79	1.81	1.92	1%
Gross Margin	36.8%	36.9%	37.2%	36.6%	32.1%	28.3%	-8.6ppt
Operating Margin	10.3%	12.5%	12.7%	14.3%	11.5%	6.1%	-6.4ppt
Income Before Tax margin	12.4%	12.7%	14.6%	12.4%	10.9%	11.9%	-0.8ppt

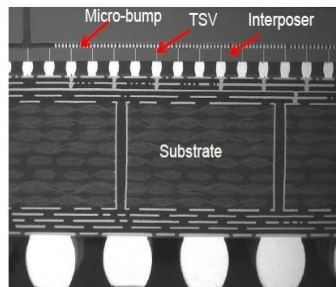
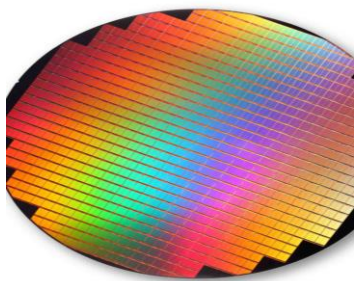
Units : %	2018	2019	2020	2021	2022	2023/H1	Gross Margin
Trading	57	59	58	60	63	69	Below Average
Manufacturing	43	41	42	40	37	31	Above Average



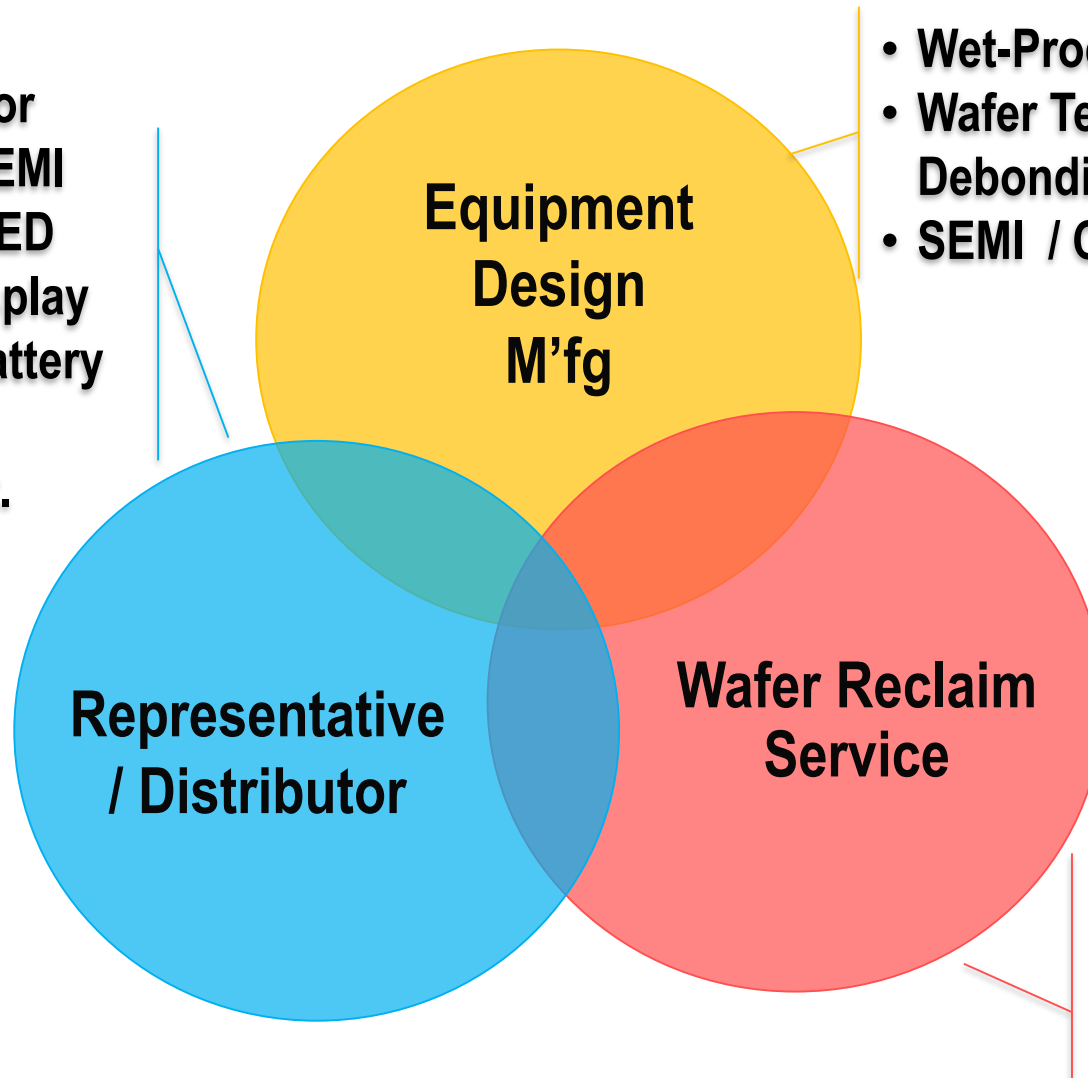
Units : NT \$ M	2018	2019	2020	2021	2022	2023/1H
R&D Expenses	246	246	248	280	320	142
Expenses as % of Revenue	6.2%	6.2%	6.9%	6.0%	5.7%	4.4%



- Industries which we serve:
 - Semiconductor (Front-End and Advanced Packaging)
 - Compound Semiconductor
 - LED / Mini LED / Micro LED
 - Flat Panel Display (TFT-LCD, AMOLED, Touch Panel)
 - Solar Cell / Battery
 - Biotech / Chemistry Analysis / Scientific Instrument,...



- Semiconductor
- Compound SEMI
- LED / Micro LED
- Flat Panel Display
- Solar Cell / Battery
- Biotech
- Scientific Inst.



- Wet-Process Tools
- Wafer Temporary Bonding Debonding System
- SEMI / Compound / LED

- 12" Si Wafer
- 6" SiC Wafer

- Sciencetech Corp.



- 12" Wafer Reclaim

- ◆ Capacity: 120K → 140K
→ 160K/ Month
- ◆ Cu and Non-Cu Process

- SiC Post Slicing Process and Reclaim

- ◆ Capacity: 800 / Month

Advanced clean technology

- 65nm/ 45nm Particle
- Low trace metal (<1E10)



Complete particle inspection
(SP1-DLS & SP2)



Complete polishing process



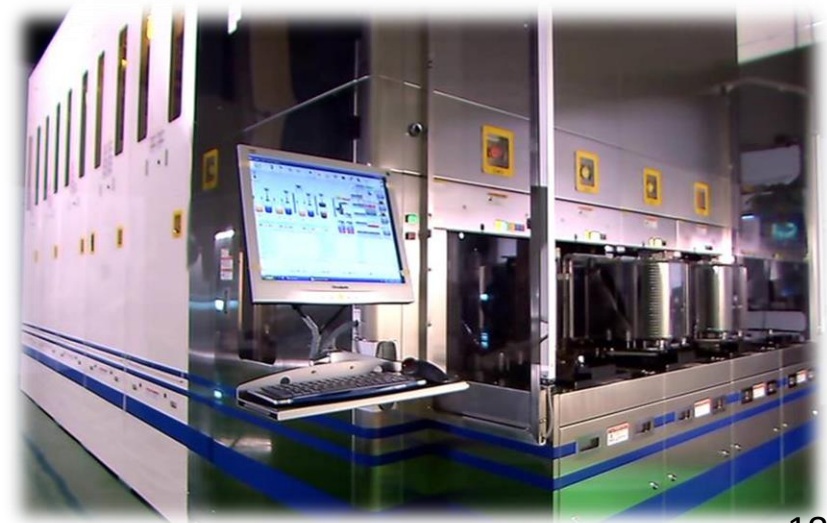
Super flatness
(GBIR<0.5μm)

- **Sciencetech Corp.**



SCIENTECH

- **Wet-Bench / Single-Wafer Wet Process Equipment**
- **Applications:**
 - ◆ Advanced Packaging Process
 - ◆ Semiconductor Front-End Process
 - ◆ Compound Semiconductor
 - ◆ Microelectromechanical Systems (MEMS)
 - ◆ High-End LED Fully-Automatic Advanced Process



- **Sciencetech Corp.**



SCIENTECH

- **Temporary Bonding Debonding System (TBDB)**
- **Application: IGBT Power Device, Advanced Packaging for Semiconductor and LED**
 - ◆ Temporary Bonding System
 - ◆ Temporary Debonding System
 - ◆ Release Layer Formation System
 - ◆ Carrier (Glass) Recycling System



Products

Trading (Agent/Distributor)





Taiwan Intellectual Property Management System

台灣智慧財產管理規範 (TIPS) 驗證登錄證書

Certificate of Taiwan Intellectual Property Management System

貴公司所建置之智慧財產管理制度，通過台灣智慧財產管理規範 (TIPS) 推行體系之驗證，特此證明。相關登錄事項如下：

- 一、公司名稱：辛耘企業股份有限公司
- 二、受評部門：全公司
- 三、受評地址：新竹縣新豐鄉中華路 18 號
- 四、證書編號：TIPS-2016-驗證-008
- 五、有效期限：2021/12/31
- 六、管理標的：☒專利 ☒商標 ☒著作權 ☒營業秘密 ☐積體電路佈局
- 排除適用：無
- 七、驗證類別：☒ AA 級 ☐ A 級 (2016 年版)

經濟部工業局 長 呂正華

Certificate of Compliance

This is to certify that the Intellectual Property Management System of the following organization has been verified and fulfilled the requirements of TIPS.

- 1. Company Name : Sciencetech Corporation
- 2. Registered Department : All Company
- 3. Registered Address : No. 18, Zhonghua Rd., Hukou Township, Hsinchu County 30352, Taiwan (R.O.C.)
- 4. Number of Registration : TIPS-2016-cert-008
- 5. Date of Expiration : December 31, 2021
- 6. Items : ☒ Patent ☒ Trademark ☒ Copyright ☒ Trade Secret ☐ Integrated Circuit Layout
- Exclusion : None
- 7. Certification Level : ☒ AA ☐ A (2016)

Director General
Intellectual Development Bureau, MOEA Richard Lee

Q & A



Thank You!